


FS3KM-9A

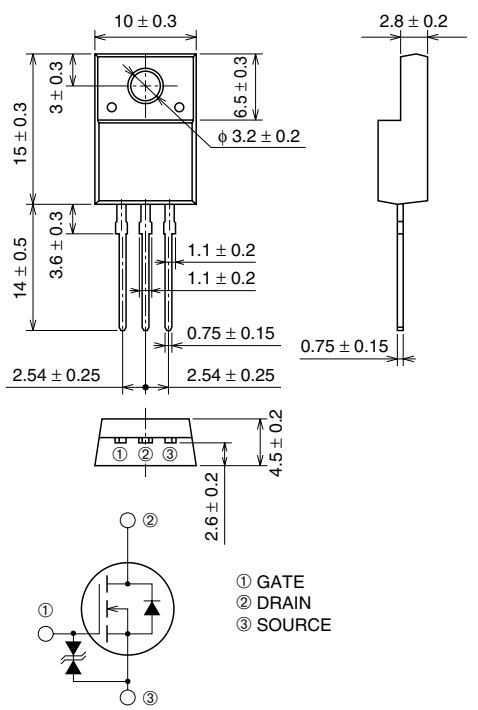
HIGH-SPEED SWITCHING USE

FS3KM-9A



- 10V DRIVE
- V_{DSS} 450V
- r_{DS (ON)} (MAX) 3.5Ω
- I_D 3A

OUTLINE DRAWING Dimensions in mm



TO-220FN

APPLICATION

SMPS, AC-adapter, Power supply of Printer, Copier, TV, VCR. etc.

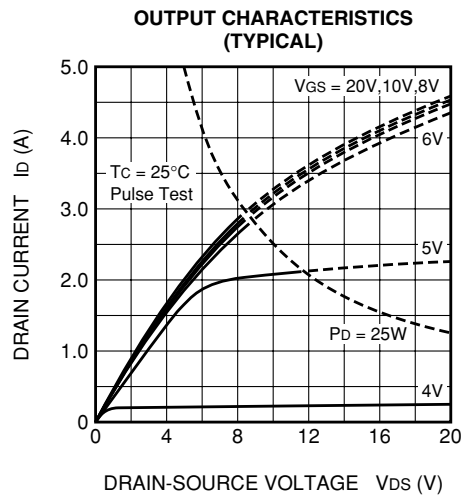
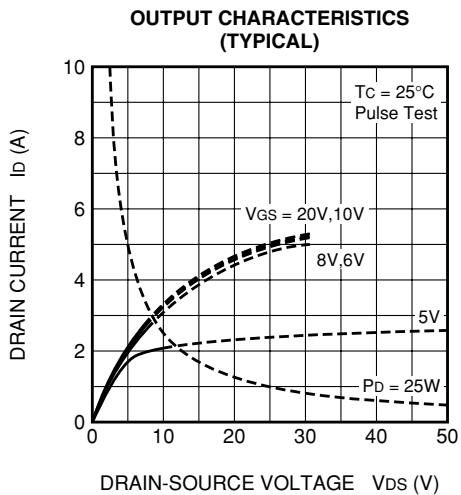
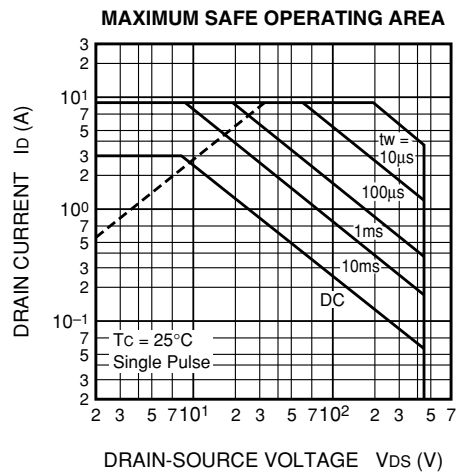
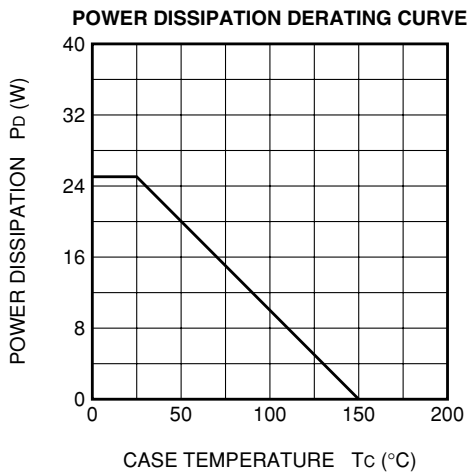
MAXIMUM RATINGS (T_c = 25°C)

Symbol	Parameter	Conditions	Ratings	Unit
V _{DSS}	Drain-source voltage	V _{GS} = 0V	450	V
V _{GSS}	Gate-source voltage	V _{DS} = 0V	±30	V
I _D	Drain current		3	A
I _{DM}	Drain current (Pulsed)		9	A
I _{DA}	Avalanche current (Pulsed)	L = 200μH	3	A
P _D	Maximum power dissipation		25	W
T _{ch}	Channel temperature		-55 ~ +150	°C
T _{stg}	Storage temperature		-55 ~ +150	°C
V _{iso}	Isolation voltage	AC for 1minute, Terminal to case	2000	V
—	Weight	Typical value	2.0	g

ELECTRICAL CHARACTERISTICS (Tch = 25°C)

Symbol	Parameter	Test conditions	Limits			Unit
			Min.	Typ.	Max.	
V (BR) DSS	Drain-source breakdown voltage	Id = 1mA, VGS = 0V	450	—	—	V
V (BR) GSS	Gate-source breakdown voltage	IGS = ±100μA, VDS = 0V	±30	—	—	V
IGSS	Gate-source leakage current	VGS = ±25V, VDS = 0V	—	—	±10	μA
IDSS	Drain-source leakage current	VDS = 450V, VGS = 0V	—	—	1	mA
VGS (th)	Gate-source threshold voltage	Id = 1mA, VDS = 10V	2.5	3.0	3.5	V
rDS (ON)	Drain-source on-state resistance	Id = 1A, VGS = 10V	—	2.60	3.50	Ω
VDS (ON)	Drain-source on-state voltage	Id = 1A, VGS = 10V	—	2.60	3.50	V
yfs	Forward transfer admittance	Id = 1A, VDS = 10V	1.2	2.0	—	S
Ciss	Input capacitance	VDS = 25V, VGS = 0V, f = 1MHz	—	280	—	pF
Coss	Output capacitance		—	35	—	pF
Crss	Reverse transfer capacitance		—	7	—	pF
td (on)	Turn-on delay time	VDD = 200V, Id = 1A, VGS = 10V, RGEN = RGS = 50Ω	—	10	—	ns
tr	Rise time		—	15	—	ns
td (off)	Turn-off delay time		—	45	—	ns
tf	Fall time		—	25	—	ns
VSD	Source-drain voltage	IS = 1A, VGS = 0V	—	1.5	2.0	V
Rth (ch-c)	Thermal resistance	Channel to case	—	—	5.00	°C/W

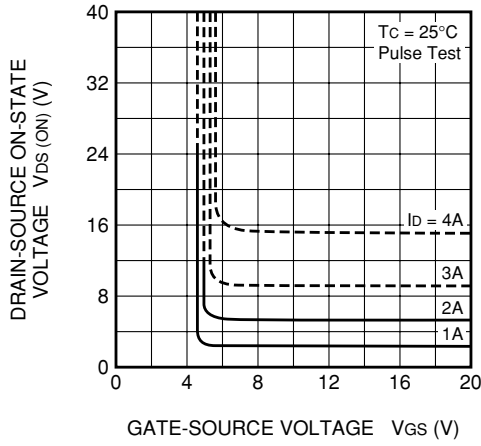
PERFORMANCE CURVES



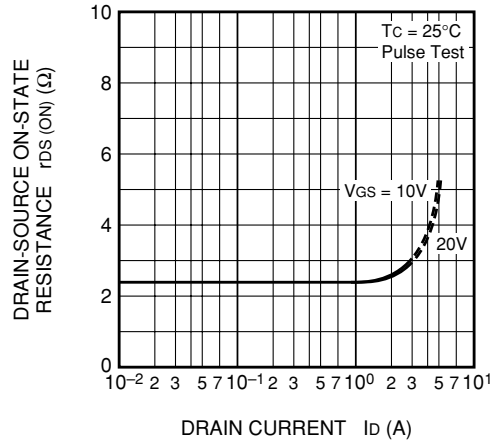
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HIGH-SPEED SWITCHING USE

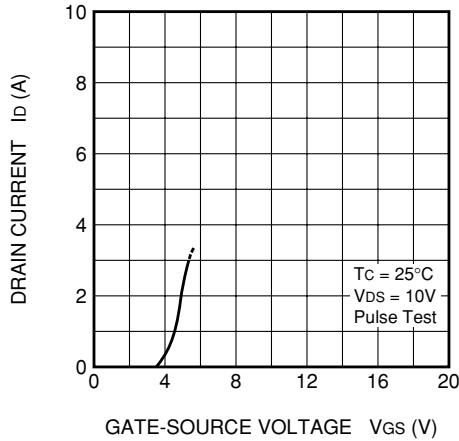
ON-STATE VOLTAGE VS. GATE-SOURCE VOLTAGE (TYPICAL)



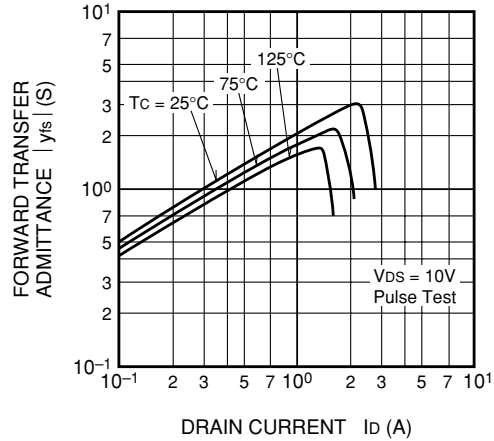
ON-STATE RESISTANCE VS. DRAIN CURRENT (TYPICAL)



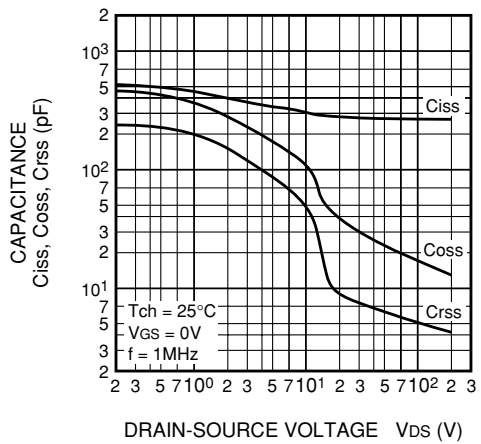
TRANSFER CHARACTERISTICS (TYPICAL)



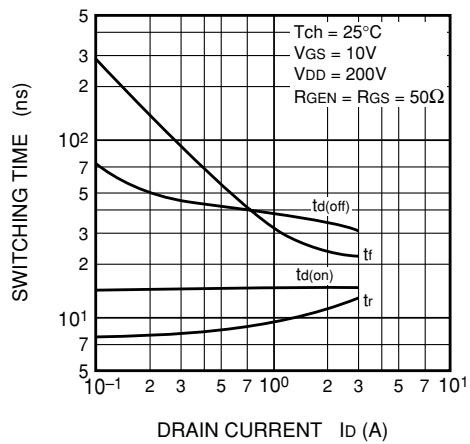
FORWARD TRANSFER ADMITTANCE VS. DRAIN CURRENT (TYPICAL)



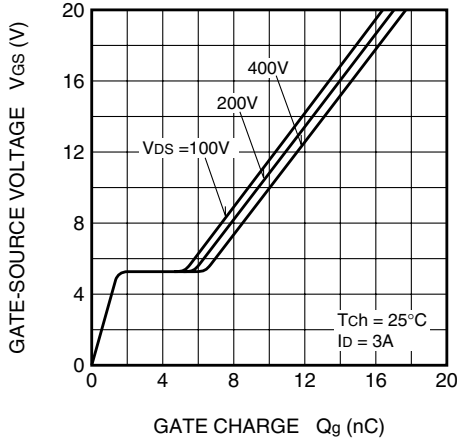
CAPACITANCE VS. DRAIN-SOURCE VOLTAGE (TYPICAL)



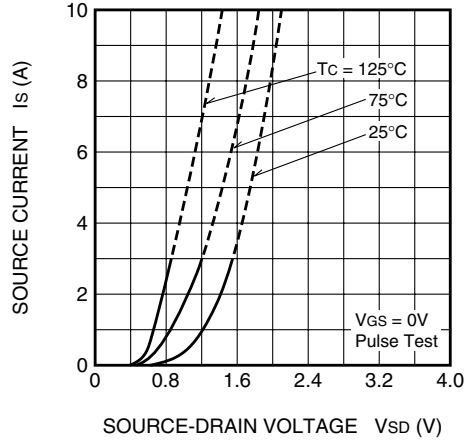
SWITCHING CHARACTERISTICS (TYPICAL)



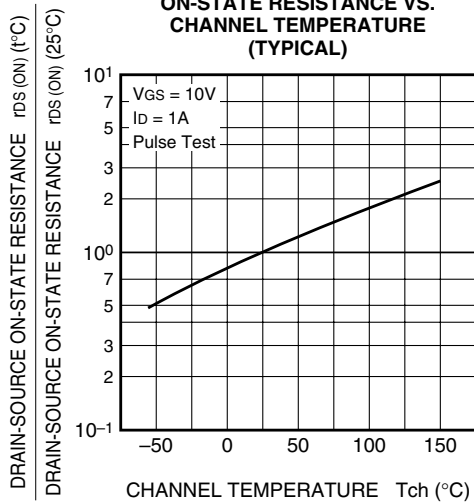
GATE-SOURCE VOLTAGE VS. GATE CHARGE (TYPICAL)



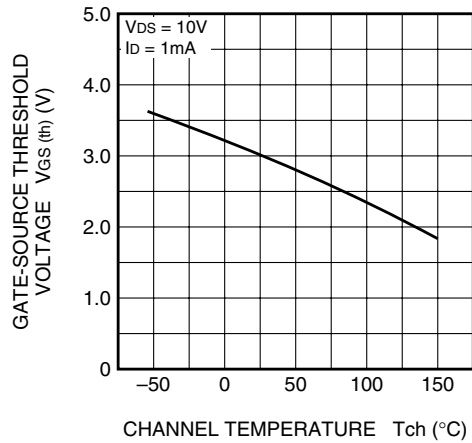
SOURCE-DRAIN DIODE FORWARD CHARACTERISTICS (TYPICAL)



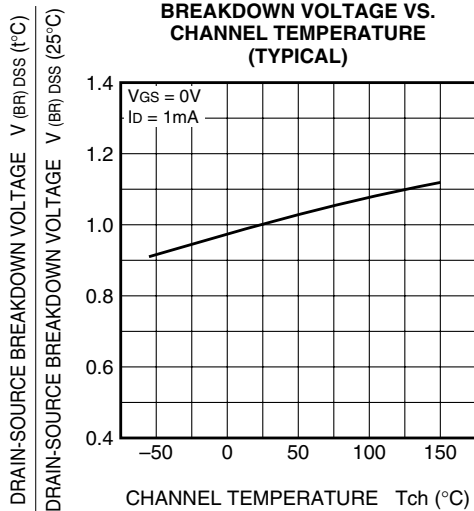
ON-STATE RESISTANCE VS. CHANNEL TEMPERATURE (TYPICAL)



THRESHOLD VOLTAGE VS. CHANNEL TEMPERATURE (TYPICAL)



BREAKDOWN VOLTAGE VS. CHANNEL TEMPERATURE (TYPICAL)



TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS

